



TECHNICAL BULLETIN

HTG-74

HIGH TEMPERATURE THERMAL GREASE

HTG-74 is a high temperature resistance thermal grease, highly filled with heat conductive metal oxides. This combination promotes high thermal conductivity, low bleed and high-temperature stability. These compounds resist changes in consistency at temperatures up to 250°C, maintaining a positive heat sink seal to improve heat transfer from the electronic device to the heat sink or chassis, thereby, increasing the overall efficiency of the device.

This material will not bleed, dry, harden or melt in normal industrial use and provides long-term material stability. It can be used for mounting semiconductor devices, power transistors, and diodes; coupling heat generating assemblies to chassis; heat transfer medium on ballast; thermal joints; and many electronics, automotive and electrical applications.

TYPICAL PROPERTIES:

Color	Gray
Specific Gravity	2.12
Evaporation, @ 200°C, 24 hrs, %/Wt	0.40
Evaporation, @ 300°C, 24 hrs, %/Wt	1.5
Operating Temperature Range	-40°C to 250°C
Thermal Conductivity @ 36°C	
W/m.°K	2.2
Thermal Resistance, °C-in2/W	0.03
Dielectric Strength (0.05" gap), Volts/mil	435
Dielectric Constant, 1 kHz	4.6
Dissipation Factor, 1 kHz	0.002
Volume Resistivity, ohm-cm	1.6x10 ₁₄

FOR INDUSTRIAL USE ONLY:

These materials are intended for industrial use only, and the practices of good housekeeping, safety and cleanliness should be followed before, during and after use.

WARNING!

Although the system contains low volatility materials, care should be taken in handling. Adequate ventilation of work place and ovens is essential. In case of skin contact, wash thoroughly with soap and water. For eyes, flush immediately with plenty of water for at least 10 minutes and seek medical attention. Refer to Material Safety Data Sheet for additional health and safety information.

SHELF LIFE:

The shelf life of these materials is greater than 2 years when stored in unopened containers at an average temperature of 25°C.